# MPL-AL4020-R82



# Low-Resistance Molded Inductor 0.82µH

#### **APPLICATIONS**



- Battery-powered devices
- Embedded computing
- High-current SMPS
- High-frequency SMPS
- POL converters
- FPGA

#### **FEATURES**

- Size 4.1mmx4.1mmx1.9mm
- Low DCR
- Low AC Losses
- Low Audible Noise
- Molded Construction
- Soft Saturation
- Stable Over High Temperatures
- Max Operating Temp +155°C
- RoHS/REACH-Compliant, Halogen-Free

ELECTRICAL CHARACTERISTICS				
Parameter			Value	Unit
Inductance (1)	L	±20%	0.82	μH
Resistance	<b>R</b> <sub>DC</sub>	typ	9.0	mΩ
Resistance MAX	RDC MAX	max	9.8	$\boldsymbol{m}\boldsymbol{\Omega}$
Rated Current (2)	<b>I</b> <sub>R</sub>	typ	8.4	Α
Saturation Current <sub>25°C</sub> (3)	ISAT 25°C	typ	9.5	Α
Saturation Current 100°C (4)	ISAT 100°C	typ	9.5	Α
Resonance Frequency	fr	typ	68	MHz

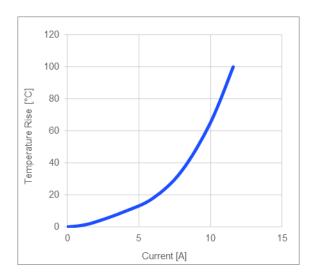
GENERAL SPECIFICATION	IS Control of the con
(1) Inductance	Measured at 100kHz, 100mA
(2) Rated Current	Rated current will cause the coil temperature rise $\Delta T$ of 40K $I_R$ measured with the inductor soldered in a single-layer PCB. Copper layer thickness 35 $\mu$ m Cu / PCB size 30x50mm. Temperature behavior dependent on circuit design, PCB layout, proximity to other components, and trace dimensions and thickness.
(3) Saturation Current 25°C	Saturation current will cause L to drop from 30% at 25°C ambient temperature
(4) Saturation Current 100°C	Saturation current will cause L to drop from 30% at 100°C ambient temperature
<b>Temperature Test Condition</b>	Electrical specifications measured at 25°C, 35% RH if not given differently
Operating Condition	Operating temperature: -40°C to +155°C (including temp rise)
	Should not exceed +155°C under worst-case operation conditions
Storage Condition	Tape and Reel packaging: -10°C to +40°C
	Humidity: <50% RH

All MPS parts are lead-free, halogen-free, and adhere to the RoHS directive. For MPS green status, please visit the MPS website under Quality Assurance. "MPS", the MPS logo, and "Simple, Easy Solutions" are registered trademarks of Monolithic Power Systems, Inc. or its subsidiaries.

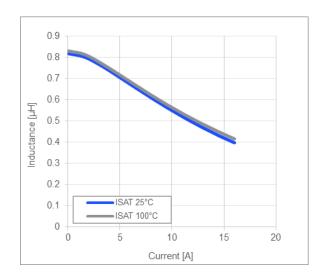


# **TYPICAL PERFORMANCE CURVES**

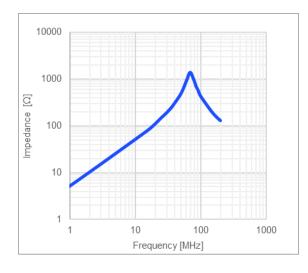
#### **Temperature Rise vs. Current**



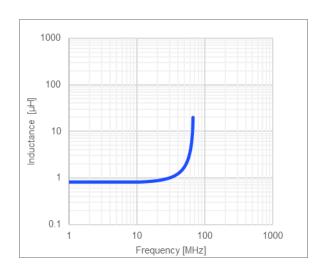
#### **Inductance vs. Current**



#### Impedance vs. Frequency

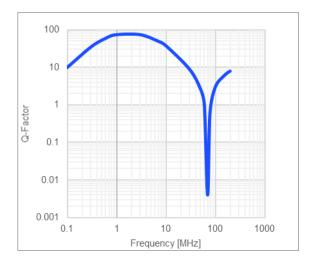


#### Inductance vs. Frequency

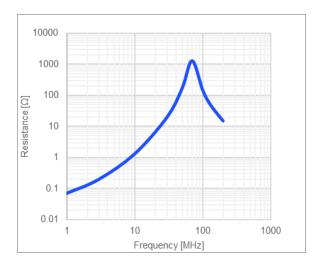




#### **Quality Factor vs. Frequency**

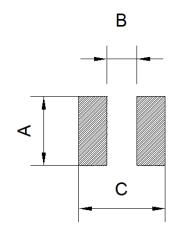


# AC Resistance vs. Frequency





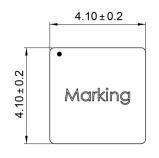
LAND PATTERN		
Dimensions		
Α	3.80 ref.	
В	1.40 ref.	
С	3.40 ref.	
	(unit in mm)	

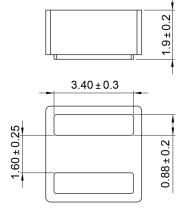


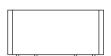
# PRODUCT PACKAGE AND DIMENSIONS

#### **Dimensions**

(unit in mm)







# **TOP MARKING**

Marki	ng	
Start of Winding	· (dot)	
Inductance Code	R82	
MPS Code	MPS	



ORDERING INFORMAT	ION				
Part Number	L (1)	RDC	<b>I</b> <sub>R</sub> <sup>(2)</sup>	ISAT 25°C (3)	ISAT 100°C (4)
	typ (µH)	typ (mΩ)	typ (A)	typ (A)	typ (A)
MPL-AL4020-R47	0.47	6.2	9.2	12.5	12.5
MPL-AL4020-R68	0.68	7.5	8.7	11	11
MPL-AL4020-R82	0.82	9.0	8.4	9.5	9.5
MPL-AL4020-1R0	1.0	10.1	7.9	8.6	8.6
MPL-AL4020-1R2	1.2	12.2	7.4	7.5	7.5
MPL-AL4020-1R5	1.5	14.5	6.4	7.1	7.1
MPL-AL4020-2R2	2.2	21.5	5.5	6.2	6.2
MPL-AL4020-3R3	3.3	34.5	4.4	5.2	5.2
MPL-AL4020-4R7	4.7	52.2	3.65	4.2	4.2

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